501849109 03/12/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

	Name	Execution Date
Toshir	iro OHKI	02/09/2012

RECEIVING PARTY DATA

Name:	FUJITSU LIMITED	
Street Address:	1-1, Kamikodanaka 4-chome, Nakahara-ku	
City:	Kawasaki-shi, Kanagawa	
State/Country:	JAPAN	
Postal Code:	211-8588	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13403329

CORRESPONDENCE DATA

Fax Number: (703)535-8420 Phone: 703-535-3960

Email: assignments@system.foundationip.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

via US Mail.

Correspondent Name: Fujitsu Patent Center Address Line 1: 2318 Mill Road

Address Line 4: Alexandria, VIRGINIA 22314

ATTORNEY DOCKET NUMBER: 10-41064

NAME OF SUBMITTER: Tiep H Nguyen

Total Attachments: 1

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PATENT REEL: 027842 FRAME: 0364 CH \$40 00 1340;

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by (Insert Name(s) & Address(es) of ASSIGNEE(S))

FUJITSU LIMITED 1-1, Kamikodanaka 4-chome, N	lakahara ku Kawasaki ah	Vananaua 241 9500 Janan
1-1, Namkodanaka 4-chome, N	akanara-ku, Nawasaki-shi	, Nanagawa 2 i i-oboo Japan
hereinafter, "ASSIGNEE"), the receipt of wassigns and transfers to ASSIGNEE the en (Title of Invention)	which is hereby acknowledged, to nitre and exclusive right, title an	he undersigned ASSIGNOR hereby self d interest to the invention entitled
SEMICONDUCTOR APPARATUS AN APPARATUS	ID METHOD FOR MANUFACT	URING SEMICONDUCTOR
relating to International Patent Application of the United States was executed on ever		or for which application for Letters Pater cuted, was:
(a) executed on	(Insert date of concurrent)	execution of application, if not
(b) filed on February 23, 201		
Serial No. 13/403,329	Assignee's insert in (b) the	attomey is hereby authorized to a specified data, when known.
nereinafter, "said application(s) and Letters The ASSIGNOR agree(s), when reques ASSIGNEE, to do all acts which the ASSIG naintaining and enforcing protection for sa application(s) and the issuance of said Let- proceeding, and in any litigation or other le- acts to include but not be limited to executir ightful caths, providing sworn testimony, a	sted by said ASSIGNEE and wit SNEE may deem necessary, de tid invention, including in the pro- ters Patent(s), in any interferen- gal proceeding which may arise ng all papers, including separate	sirable or expedient, for securing, eparation and prosecution of said ce, reissue, reexamination, or public usi or be declared in relation to same, such assignments and declarations, taking a
IN WITNESS WHEREOF, the undersig	ned inventor(s) has (have) affix	ed his/her/their signature(s).
1) 77 + 12 2/2 (Signature)	Toshihire Ohki	Feb. 9, 2012
(Signature)	(Type Name)	Feb. 9, 2012 (Date)
2)		1
(Signature)	(Type Name)	(Date)
(Signature)	(Type Name)	(Date)
(-	C No. of the last	Company and No.
(Signature)	(Type Name)	(Date)

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PATENT REEL: 027842 FRAME: 0365